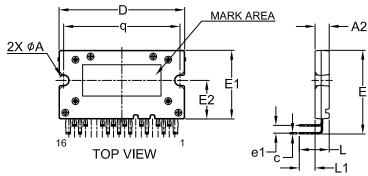
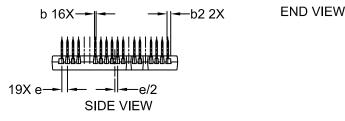


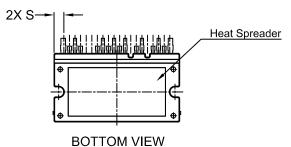
APMCA-B16 / 16LD, AUTOMOTIVE MODULE

CASE MODGJ ISSUE C

DATE 03 NOV 2021







NOTES:

- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14,5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
A2	4.30	4.50	4.70
b	0.45	0.50	0.60
b2	1.15	1.20	1.30
С	0.45	0.50	0.60
D	39.90	40.10	40.30
Е	26.20	26.70	27.20
E1	21.70	21.90	22.10
E2	12.10	12.30	12.50
е	1.478	1.778	2.078
e1	2.20	2.50	2.80
L	9.20	9.55	9.90
L1	5.05 REF		
q	36.85	37.10	37.35
S	3.159 REF		
ΦA	3.00	3.20	3.40

GENERIC MARKING DIAGRAM*

XXXX = Specific Device Code

ZZZ = Lot ID

AT = Assembly & Test Location

Y = Year W = Work

W = Work Week
NNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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